

Electrical Characteristics (T_A = 25 °C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units	
OFF CHARACTERISTICS							
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	25			V	
ΔBV _{DSS} /ΔT _J	Breakdown Voltage Temp. Coefficient	I _D = 250 μA, Referenced to 25 °C		26		mV / °C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 20 V, V _{GS} = 0 V T _J = 55°C			1 10	μA μA	
I _{GSS}	Gate - Body Leakage Current	V _{GS} = 8 V, V _{DS} = 0 V			100	nA	
ON CHARACTERISTICS (Note)							
ΔV _{GS(th)} /ΔT _J	Gate Threshold Voltage Temp. Coefficient	I _D = 250 μA, Referenced to 25 °C		-2.6		mV / °C	
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	0.65	0.8	1.5	V	
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} = 4.5 V, I _D = 0.5 A T _J =125°C V _{GS} = 2.7 V, I _D = 0.2 A		0.33 0.52 0.44	0.45 0.8 0.6	Ω	
I _{D(ON)}	On-State Drain Current	V _{GS} = 2.7 V, V _{DS} = 5 V	0.5				A
g _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 0.5 A		1.45			S
DYNAMIC CHARACTERISTICS							
C _{iss}	Input Capacitance	V _{DS} = 10 V, V _{GS} = 0 V, f = 1.0 MHz		50		pF	
C _{oss}	Output Capacitance			28		pF	
C _{rss}	Reverse Transfer Capacitance			9		pF	
SWITCHING CHARACTERISTICS (Note)							
t _{D(on)}	Turn - On Delay Time	V _{DD} = 6 V, I _D = 0.5 A, V _{GS} = 4.5 V, R _{GEN} = 50 Ω		3	6	ns	
t _r	Turn - On Rise Time			8.5	18	ns	
t _{D(off)}	Turn - Off Delay Time			17	30	ns	
t _f	Turn - Off Fall Time			13	25	ns	
Q _g	Total Gate Charge	V _{DS} = 5 V, I _D = 0.5 A, V _{GS} = 4.5 V		1.64	2.3	nC	
Q _{gs}	Gate-Source Charge			0.38		nC	
Q _{gd}	Gate-Drain Charge			0.45		nC	
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS							
I _S	Maximum Continuous Drain-Source Diode Forward Current				0.3	A	
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 0.5 A (Note)		0.83	1.2	V	

Note:

Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2.0%.